ASSOCIATION CONNECTING LECTRONICS INDUSTRIES® INDUSTRIES® INTERNATIONAL INDUSTRIES®	PC. Bannockl	burn. Illinois. A	Il rights reserved untions.	under both	This docum level parts, t	ent is a declara the declaration	ion of the s encompasse	ubstances es all lowe	within the neer level mate	nanufacture rials for wh	er listed ite nich the ma	m. Note: nufacture	if the item is an as r has engineering	sembly with lower responsibility.
				Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ous Materia	ials and Mfg Information			
Supplier Information														
Company name* Comp			Company unique ID			Unique ID Authority					Response Date*			
onsemi											2024-05-03			
Contact Name Title - Contact					Phone - Contact*						Email - Contact*			
Product-Env-Stewards Product			oduct Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - F			tle - Representative			Phone - Representative*				Email - Representative*				
Product-Env-Stewards Pr			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Requester Item Number	Requester Item Number Mfr Item		Number Mfr Item Name			Effective Date	e Version		Manufacturing Site		W	eight*	UOM	Unit Type
	NSBA12	NSBA124XF3T5G PNP Digital Tran		sistor (BRT)		2024-05-03					0.4	45	mg	Each
Manufacturing Proccess Informa	tion										·		·	
Terminal Plating / Grid Array M	ay Material Terminal Base Alloy			J-STD-020 MSI	0 MSL Rating Peal		eak Process Body Temperature Max Time at Peak		Temperature Number of Reflow Cycles		eles			
Matte Tin (Sn) - annealed CU Alloy		CU Alloy		1		260		С	30		second	3		
Comments														
evel 1 - maximum time at peak temperat	ire during so	Idering is 10-3	0 seconds											
for more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed			
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth				
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of			
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted				
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all			
Exemption List Version	EL-2011/534/EU							
Declaration Signature								
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.								
Supplier Digital Signature Ra	stislav Drska	Le						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless	otherwise noted).				-	-		-
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.03	mg	Supplier	Silicon (Si)	7440-21-3		0.03	mg
Lead Frame	0.2	mg	Supplier	Silver (Ag)	7440-22-4		0.0356	mg
			В	Nickel (Ni)	7440-02-0		0.0618	mg
			Supplier	Iron (Fe)	7439-89-6		0.0854	mg
			Supplier	Copper (Cu)	7440-50-8		0.0172	mg
Mold Compound-Black	0.19	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.019	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0009	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.0275	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		0.1235	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.019	mg
Plating	0.02	mg	Supplier	Tin (Sn)	7440-31-5		0.02	mg
Wire Bond - Cu	0.01	mg	Supplier	Copper (Cu)	7440-50-8		0.01	mg